TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC7240AP, TC74HC7240AF TC74HC7244AP, TC74HC7244AF

Octal Bus Buffer (with schmitt trigger inputs)

TC74HC7240AP/AF Inverted, 3-State Outputs TC74HC7244AP/AF Non-Inverted, 3-State

Outputs

The TC74HC7240A/7244A are high speed CMOS OCTAL BUS BUFFERs with silicon gate $\rm C^2MOS$ technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

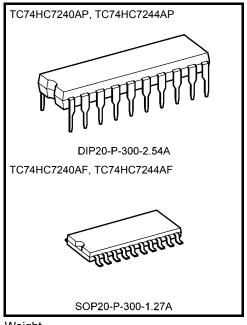
The TC74HC7240A/7244A have same pin configuration and function as the TC74HC240A/244A. And they have a hystereis characterictics with each input, so TC74HC7240A/7244A can be used as a line receiver, etc.

They have two active low output enables.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: $t_{pd} = 15 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25 \text{°C}$
- High noise immunity: $V_H = 1.1 \text{ V (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: $|I_{OH}| = I_{OL} = 6 \text{ mA (min)}$
- Balanced propagation delays: t_{pLH} ≃ t_{pHL}
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS240/244

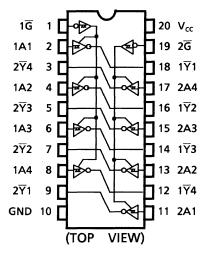


Weight

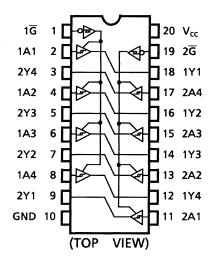
DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

Pin Assignment

TC74HC7240A



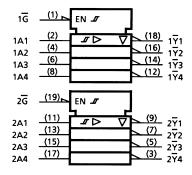
TC74HC7244A



Start of commercial production 1988-11

IEC Logic Symbol

TC74HC7240A



TC74HC7244A

1G	(1)	EN -	
1A1 1A2 1A3 1A4	(2) (4) (6) (8)	J ▷ ▽	(18) 1Y1 (16) 1Y2 (14) 1Y3 (12) 1Y4
2G	(19)	EN 🌃	1
			•

Truth Table

Inp	uts	Outputs			
G	A _n	Yn	\overline{Y}_n		
L	L	L	Н		
L	Н	Н	L		
Н	Х	Z	Z		

 Δ : For TC74HC7240A only

X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	−0.5 to V _{CC} + 0.5	V
Input diode current	l _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V _{CC} /ground current	Icc	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65° C. From Ta = 65 to 85° C a derating factor of -10 mW/°C shall be applied until 300 mW.



Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	−40 to 85	°C

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition			Ta = 25°C)	Ta = -40 to 85°C		Unit
					Min	Тур.	Max	Min	Max	O i iii
				2.0	1.0	1.25	1.5	1.0	1.5	
Positive threshold voltage	V_{P}	_		4.5	2.3	2.7	3.15	2.3	3.15	V
J				6.0	3.0	3.5	4.2	3.0	4.2	
				2.0	0.3	0.65	0.9	0.3	0.9	
Negative threshold voltage	V_N		_	4.5	1.13	1.6	2.0	1.13	2.0	V
J				6.0	1.5	2.3	2.6	1.5	2.6	
				2.0	0.3	0.6	1.0	0.3	1.0	
Hysteresis voltage	V_{H}	_		4.5	0.6	1.1	1.4	0.6	1.4	V
				6.0	0.8	1.2	1.7	0.8	1.7	
	V _{ОН}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	2.0	_	1.9	_	
				4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
	V _{OL} V _{IN} = V _{IH}	V _{IN} = V _{IH} or V _{IL}		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage				6.0		0.0	0.1	_	0.1	V
			I _{OL} = 6 mA	4.5	_	0.17	0.26	_	0.33	
			I _{OL} = 7.8 mA	6.0		0.18	0.26	_	0.33	
3-state output off-state current	I _{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND		6.0	_	_	±0.5	_	±5.0	μА
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0		_	±0.1	_	±1.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		6.0	_	_	4.0	_	40.0	μА



AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
	- J		CL (pF)	V _{CC} (V)	Min	Тур.	Max	Min	Max	
Output transition time	4			2.0	_	25	60	_	75	
	t _{TLH}	_	50	4.5	_	7	12	_	15	ns
	t _{THL}			6.0	_	6	10	_	13	
				2.0	_	50	125	_	155	
			50	4.5	_	15	25	_	31	
Propagation delay	t_{pLH}			6.0	_	13	21	_	26	ns
time	t_{pHL}			2.0	_	67	165	_	205	113
			150	4.5	_	20	33	_	41	
				6.0	_	17	28	_	35	
	t _P ZL t _P ZH	R _L = 1 kΩ	50	2.0	_	68	150	_	190	
				4.5	_	21	30	_	38	
Output enable time				6.0	_	16	26		32	ns
Output enable time			150	2.0	_	84	165	_	230	113
				4.5	_	26	37	_	46	
				6.0	_	20	31		39	
	+			2.0	_	48	150	_	190	
Output disable time	t_{pLZ} t_{pHZ} $R_L = 1 \text{ k}\Omega$	$R_L = 1 k\Omega$	50	4.5	_	21	30	_	38	ns
				6.0	_	19	26	_	32	
Input capacitance	C _{IN}	_	-		_	5	10		10	pF
Output capacitance	C _{OUT}	_	-		_	10	_	_	_	pF
Power dissipation	C _{PD}	TC74HC7240A			_	33	_	_	_	ηE
capacitance	(Note)	TC74HC7244A			_	34	_		_	- pF

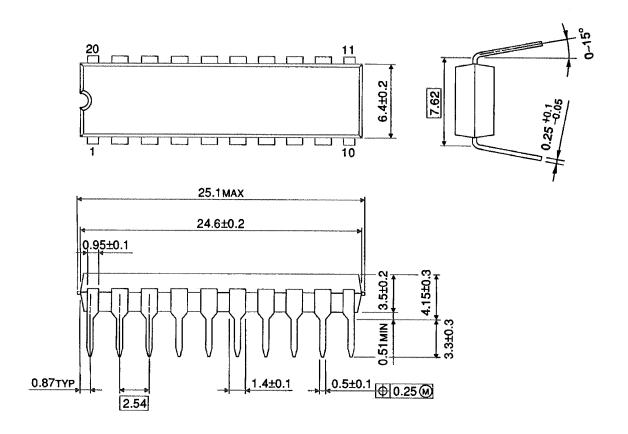
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$ (per bit)

Package Dimensions

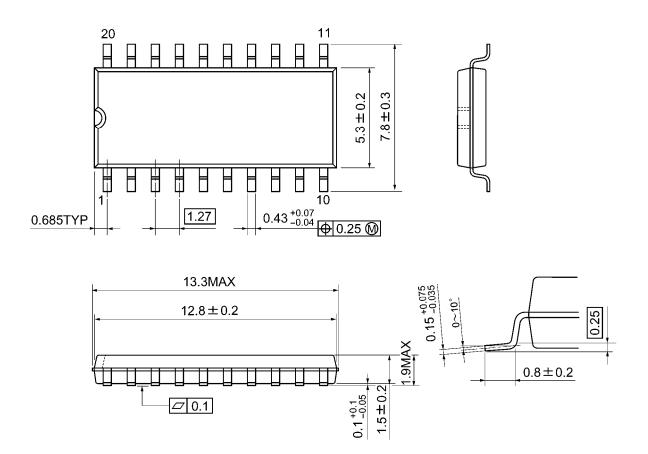
DIP20-P-300-2.54A Unit: mm



Weight: 1.30 g (typ.)

Package Dimensions

SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

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